

Dual N-channel 40 V, 29 mOhm logic level MOSFET inLFPAK56D using Repetitive Avalanche technology2 December 2020Product data sheet

1. General description

Dual, logic level N-channel MOSFET in an LFPAK56D package, using Application Specific (ASFET) repetitive avalanche silicon technology. This product has been designed and qualified to AEC-Q101 for use in repetitive avalanche applications.

2. Features and benefits

- Fully automotive qualified to AEC-Q101 at 175 °C
 - Repetitive Avalanche rated to 30 °C T_i rise:
 - Tested to 1 Bn avalanche events
- LFPAK copper clip package technology:
 - High robustness and reliability
 - Gull wing leads for high manufacturability and AOI

3. Applications

- 12 V, 24 V and 48 V automotive systems
- Repetitive avalanche topologies
- Engine control
- Transmission control
- Actuator and auxiliary loads

4. Quick reference data

Table 1. Quick	reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C	-	-	40	V
I _D	drain current	V _{GS} = 5 V; T _{mb} = 25 °C; <u>Fig. 2</u>	-	-	18.2	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>	-	-	32	W
Static characte	eristics FET1 and FET2					
R _{DSon}	drain-source on-state resistance	V _{GS} = 5 V; I _D = 5 A; T _j = 25 °C; <u>Fig. 14</u>	-	24	29	mΩ
Dynamic chara	cteristics FET1 and FE	T2		,		
Q _{GD}	gate-drain charge	$ I_D = 5 \text{ A}; V_{DS} = 32 \text{ V}; V_{GS} = 5 \text{ V}; T_j = 25 °C; Fig. 16; Fig. 17 $	-	2.4	-	nC

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5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S1	source1	8 7 6 5	D1 D1 D2 D2
2	G1	gate1		
3	S2	source2		
4	G2	gate2		
5	D2	drain2		
6	D2	drain2		S1 G1 S2 G2
7	D1	drain1		mbk725
8	D1	drain1	LFPAK56D; Dual LFPAK (SOT1205)	

6. Ordering information

Table 3. Ordering information						
Type number	Package	age				
	Name	Description	Version			
BUK9K25-40RA	LFPAK56D; Dual LFPAK	plastic, single ended surface mounted package (LFPAK56D); 8 leads	SOT1205			

7. Marking

Table 4. Marking codes	
Type number	Marking code
BUK9K25-40RA	92540RA

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Мах	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		-	40	V
V _{DGR}	drain-gate voltage	R _{GS} = 20 kΩ		-	40	V
V _{GS}	gate-source voltage	Pulsed; T _j ≤ 175 °C	[1] [2]	-15	15	V
		DC; T _j ≤ 175 °C		-10	10	V
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>		-	32	W
I _D	drain current	V _{GS} = 5 V; T _{mb} = 25 °C; <u>Fig. 2</u>		-	18.2	А
		V _{GS} = 5 V; T _{mb} = 100 °C; <u>Fig. 2</u>		-	16.6	А
I _{DM}	peak drain current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$; Fig. 3		-	94	А
T _{stg}	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
Source-drai	n diode FET1 and FET2			_	-	
I _S	source current	T _{mb} = 25 °C		-	18.2	А
I _{SM}	peak source current	pulsed; t _p ≤ 10 µs; T _{mb} = 25 °C		-	94	A

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Symbol	Parameter	Conditions		Min	Мах	Unit
Avalanche rug	ggedness					
E _{DS(AL)R}	repetitive drain-source avalanche energy	$ \begin{array}{l} I_{D} = 0.73 \; A; \; V_{sup} \leq 40 \; V; \; R_{GS} = 10 \; \Omega; \; V_{GS} \\ \texttt{=}10 \; V; \; T_{j(rise)} \leq 30 \; ^{\circ}C; \; unclamped; \; \underline{Fig. 4}; \\ \hline Fig. 5; \; \overline{Fig. 6} \end{array} $	[3] [4] [5]	-	19	mJ
Avalanche rug	ggedness FET1 and FET2		Ċ			
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	$ I_D = 18.2 \text{ A}; V_{sup} \le 40 \text{ V}; V_{GS} = 10 \text{ V}; \\ T_{j(init)} = 25 \text{ °C}; \text{ Fig. 7} $	[6] [7]	-	15	mJ

[1] Accumulated Pulse duration up to 50 hours delivers zero defect ppm.

[2] Significantly longer life times are achieved by lowering T₁ and or V_{GS}.

[3] Repetitive avalanche rating is limited by maximum junction temperature of 175 °C and junction rise of 30 °C

[4] Refer to Fig. 5 for the limiting number of avalanche events

[5] Refer to Fig. 6 Rdson at Vgs=5V will increase as a function of repetitive avalanche cycles

[6] Refer to application note AN10273 for further information

[7] Single-pulse avalanche rating limited by maximum junction temperature of 175 °C



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Fig. 7.

T_{j (init)} = 25 °C

10-1

10

t_{AL} (ms)

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10⁻²

Single pulse avalanche rating; avalanche current as a function of avalanche time

1

10-1 10⁻³

9. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	Fig. 8	-	-	4.68	K/W
R _{th(j-a)}		Minimum footprint; mounted on a printed circuit board	-	95	-	K/W



10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	cteristics FET1 and FET2					
V _{(BR)DSS}	drain-source	$I_D = 250 \ \mu A; V_{GS} = 0 \ V; T_j = -55 \ ^{\circ}C$	36	-	-	V
	breakdown voltage	I _D = 250 μA; V _{GS} = 0 V; T _j = 25 °C	40	-	-	V
V _{GS(th)}	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS}=V_{GS}; T_j = 25 \text{ °C}; Fig. 12;$ Fig. 13	1.4	1.7	2.1	V
		I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 175 °C; Fig. 12; Fig. 13	0.5	-	-	V
		I _D = 1 mA; V _{DS} =V _{GS} ; T _j = -55 °C; Fig. 12; Fig. 13	-	-	2.45	V
I _{DSS}	drain leakage current	V _{DS} = 40 V; V _{GS} = 0 V; T _j = 175 °C	-	-	500	μA
		V _{DS} = 40 V; V _{GS} = 0 V; T _j = 25 °C	-	- 0.02 1	1	μA
I _{GSS}	gate leakage current	V _{GS} = -10 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
		V _{GS} = 10 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
R _{DSon}	drain-source on-state resistance	V _{GS} = 5 V; I _D = 5 A; T _j = 25 °C; <u>Fig. 14</u>	-	24	29	mΩ
		V _{GS} = 5 V; I _D = 5 A; T _j = 175 °C; <u>Fig. 14;</u> Fig. 15	-	48.2	58	mΩ
		V _{GS} = 10 V; I _D = 5 A; T _i = 25 °C; <u>Fig. 14</u>	-	19	24	mΩ

BUK9K25-40RA

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	technology unbol Parameter Conditions Min Typ Max Unit								
Symbol	Parameter	Conditions	Min	Тур	Max	Unit			
Dynamic cl	haracteristics FET1 and FE	T2							
Q _{G(tot)}	total gate charge	I _D = 5 A; V _{DS} = 32 V; V _{GS} = 5 V;	-	6.3	-	nC			
Q _{GS}	gate-source charge	T _j = 25 °C; <u>Fig. 16; Fig. 17</u>	-	1.4	-	nC			
Q _{GD}	gate-drain charge		-	2.4	-	nC			
C _{iss}	input capacitance	V _{DS} = 25 V; V _{GS} = 0 V; f = 1 MHz; T _j = 25 °C; <u>Fig. 18</u>	-	528	701	pF			
C _{oss}	output capacitance		-	95	114	pF			
C _{rss}	reverse transfer capacitance		-	56	76	pF			
t _{d(on)}	turn-on delay time	$V_{DS} = 32 \text{ V}; \text{ R}_{L} = 6.4 \Omega; V_{GS} = 5 \text{ V};$ $R_{G(ext)} = 5 \Omega; \text{ T}_{j} = 25 ^{\circ}\text{C}$	-	6.2	-	ns			
t _r	rise time		-	9.2	-	ns			
t _{d(off)}	turn-off delay time		-	10.8	-	ns			
t _f	fall time		-	8.9	-	ns			
Source-dra	ain diode FET1 and FET2								
V _{SD}	source-drain voltage	I _S = 5 A; V _{GS} = 0 V; T _j = 25 °C; <u>Fig. 19</u>	-	0.83	1.2	V			
t _{rr}	reverse recovery time	$I_{S} = 5 \text{ A}; \text{ d}I_{S}/\text{d}t = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V};$	-	15.9	-	ns			
Q _r	recovered charge	V _{DS} = 20 V; T _j = 25 °C	-	7.6	-	nC			







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BUK9K25-40RA

Dual N-channel 40 V, 29 mOhm logic level MOSFET in LFPAK56D using Repetitive Avalanche technology

11. Package outline



Dual N-channel 40 V, 29 mOhm logic level MOSFET in LFPAK56D using Repetitive Avalanche technology

12. Soldering



13. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Contents

1.	General description	1
2.	Features and benefits	1
3.	Applications	1
4.	Quick reference data	1
5.	Pinning information	2
6.	Ordering information	2
7.	Marking	2
8.	Limiting values	2
9.	Thermal characteristics	5
10.	Characteristics	5
11.	Package outline	10
	Soldering	
	. Legal information	
	-	

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